

## Description

The AS2376Q is a low noise  $(9.5 \text{nV}/\sqrt{\text{Hz}})$ , low offset  $(25 \mu \text{V}, \text{maximum})$ , operational amplifier that is precision optimized by using post-package trim. With a 5.5MHz bandwidth, the device is suitable for a wide array of filtering and control applications. The low voltage operation, low quiescent current of  $950 \mu \text{A}$  (maximum), and excellent PSRR makes the AS2376Q suitable for direct battery-powered applications and noise-sensitive applications with noisy low-voltage rails.

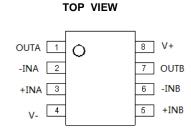
The dual AS2376Q is offered in the SO-8 and MSOP-8 package, specified for operation from -40°C to +125°C. The device is qualified to AEC-Q100 Grade 1 with automotive-grade supporting PPAPs.

## **Features**

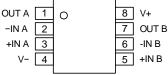
- Low Noise: 9.5nV/√Hz at 1kHz
- 0.1Hz to 10Hz Noise: 0.8µV<sub>PP</sub>
- Quiescent Current: 760µA (typical)
- Low Offset Voltage: 5µV (typ)
- Gain Bandwidth Product: 5.5MHz
- Rail-to-Rail Input and Output
- Single-Supply Operation
- Supply Voltage: 2.2V to 5.5V
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The AS2376Q is suitable for automotive applications requiring specific change control; this part is AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Pin Assignments**







MSOP-8

## Applications

- Auto pumps
- Position sensors
- Vehicle occupant detection sensors
- Airbags
- Onboard charges (OBC)
- DC-DC converters
- Battery management systems (BMS)

Notes:

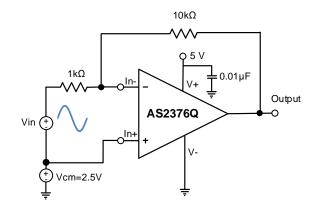
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



# **Typical Applications Circuit**

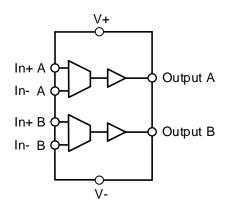


#### **Basic Single Power Amplifier Connection**

# **Pin Description**

|       | PIN         |     | DESCRIPTION                     |  |
|-------|-------------|-----|---------------------------------|--|
| NAME  | SO-8/MSOP-8 | I/O | DESCRIPTION                     |  |
| +IN A | 3           | I   | Noninverting input, channel A   |  |
| +IN B | 5           | I   | Noninverting input, channel B   |  |
| –IN A | 2           | I   | Inverting input, channel A      |  |
| –IN B | 6           | I   | Inverting input, channel B      |  |
| OUT A | 1           | 0   | Output, channel A               |  |
| OUT B | 7           | 0   | Output, channel B               |  |
| V+    | 8           | —   | Positive (highest) power supply |  |
| V-    | 4           | —   | Negative (lowest) power supply  |  |

# **Functional Block Diagram**



# AS2376Q Functional Block



| Symbol                                       | Parameter                                     | Rati   | Rating      |       |
|--|---|--------|-------------|-------|
| V+ -V-                                       | Supply Voltage                                | 6.5    | 5           | V     |
| -  | Output Short Circuit to V+                    | (Note  | e 5)        | -     |
| -  | Output Short Circuit to V-                    | (Note  | e 6)        | -     |
| 0  | Signal input terminals (Note 7)               | (Note  | e 7)        | mA    |
| Current                                      | Output short-circuit (Note 8)                 | Contin | uous        | mA    |
| T <sub>ST</sub>                              | Storage Temperature                           | -65 to | -65 to +150 |       |
| TJ   | Maximum Junction Temperature                  | +15    | +150        |       |
| T <sub>LEAD</sub>                            | Lead Temperature (Soldering, 10 Seconds)      | +26    | 60          | °C    |
| P  | han attend to Analytical Theory of Desistance | SO-8   | 115         | *0111 |
| $R_{\theta JA}$                              | Junction-to-Ambient Thermal Resistance        | MSOP-8 | 210         | °C/W  |
| D  | handling to Orace Thermal Desigtance          | SO-8   | 18          | °C/W  |
| $R_{	ext{	ext{	ext{	ext{	ext{	ext{	ext{	ext$ | Junction-to-Case Thermal Resistance           | MSOP-8 | MSOP-8 40   |       |
| ESD HBM                                      | Human Body Model ESD Protection               | 4      |             | kV    |
| ESD CDM                                      | Charged-device Model ESD Protection           | 1      |             | kV    |

### Absolute Maximum Ratings (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

4. Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.
5. Shorting output to V+ will adversely affect reliability.
6. Shorting output to V- will adversely affect reliability.
7. Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current limited to 10m Ac tess. Notes:

limited to 10mA or less.

8. Short-circuit to ground.

## **Recommended Operating Conditions**

| Symbol          | Parameter                           | Min | Мах  | Unit |
|-----------------|-------------------------------------|-----|------|------|
| V <sub>cc</sub> | Supply Voltage                      | 2.2 | 5.5  | V    |
| T <sub>A</sub>  | Ambient Operating Temperature Range | -40 | +125 | °C   |



# **Electrical Characteristics** (Limits in standard typeface are for $T_A = +25^{\circ}$ C, **bold** typeface applies over -40°C to +125°C (Note 9), $R_L = 10k\Omega$ connected to $V_S / 2$ , $V_{CM} = V_S / 2$ , and $V_{OUT} = V_S / 2$ , unless otherwise noted.)

| SYMBOL                     | PARAMETER                                  | TEST CONDITIONS   | MIN                     | TYP         | MAX                     | UNIT   |
|----------------------------|--|---|-------------------------|-------------|-------------------------|--------|
| OFFSET VOL                 | TAGE                                       |   |                         |             |                         |        |
|                            |  | -   | -                       | 5           | 25                      | μV     |
| Vos                        | Input offset voltage                       | Long-term stability (Note 11)   | -                       | -           | 60                      | μV     |
|                            | (Note 10)                                  | Package level shift (Note 12)   | -                       | -           | 320                     | μV     |
|                            |  | $T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$                             | -                       | 0.26        | 1.2                     | µV/°C  |
| $\Delta V_{OS} / \Delta T$ | Input offset voltage versus<br>temperature | T <sub>A</sub> = -40°C to +125°C  | -                       | 0.32        | 2                       | µV/°C  |
|                            | ·  | $T_A = 25^{\circ}C$ , $V_S = 2.2V$ to 5.5 V, $V_{CM} < (V^+) - 1.3 V$       | -                       | 5           | 20                      | μV/V   |
| PSRR                       | Input offset voltage versus                | $T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$                            |                         | F           |                         |        |
|                            | power supply                               | $V_{\rm S}$ = 2.2 V to 5.5 V, $V_{\rm CM}$ < (V^+) $-$ 1.3 V                | -                       | 5           | -                       | μV/V   |
| -                          | Channel separation, dc                     |   | -                       | 0.5         | -                       | mV/V   |
| NPUT BIAS                  | CURRENT                                    |   |                         |             |                         |        |
|                            |  | $T_A = 25^{\circ}C$   | -                       | 0.2         | 70                      | pА     |
| Ι <sub>Β</sub>             | Input bias current                         | $T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$                            | See Typ                 | oical Chara | cteristics              | pА     |
| IOS                        | Input offset current                       |   | -                       | 0.2         | 70                      | pА     |
| NOISE                      |  |   |                         |             |                         | -      |
| -                          | Input voltage noise                        | f = 0.1 Hz to 10 Hz   | -                       | 0.8         | -                       | μVPP   |
| en                         | Input voltage noise<br>density             | f = 1 kHz   | -                       | 9.5         | -                       | nV/√Hz |
| I <sub>n</sub>             | Input current noise                        | f = 1 kHz   | -                       | 2           | -                       | fA/√Hz |
| INPUT VOLT                 | AGE RANGE                                  |   |                         |             |                         |        |
| V <sub>CM</sub>            | Common-mode voltage<br>range               | -   | (V <sup>−</sup> ) – 0.1 | -           | (V <sup>+</sup> ) + 0.1 | V      |
| CMRR                       | Common-mode rejection ratio                | $(V^{-}) < V_{CM} < (V^{+}) - 1.3 V$  | 76                      | 90          |                         | dB     |
| NPUT CAPA                  | CITANCE                                    |   |                         |             |                         |        |
| -                          | Differential                               | -   | -                       | 6.5         | -                       | pF     |
| -                          | Common-mode                                | -   | -                       | 13          | -                       | pF     |
| OPEN-LOOP                  | GAIN                                       |   |                         |             |                         |        |
|                            |  | 50 mV < V <sub>0</sub> < (V <sup>+</sup> ) – 50 mV, R <sub>L</sub> = 10 kΩ  | 120                     | 134         | -                       | dB     |
| A <sub>OL</sub>            | Open-loop voltage gain                     | 100 mV < V <sub>0</sub> < (V <sup>+</sup> ) – 100 mV, R <sub>L</sub> = 2 kΩ | 120                     | 126         | -                       | dB     |
| FREQUENC                   | / RESPONSE C <sub>L</sub> = 100 pF, \      | / <sub>s</sub> = 5.5 V  |                         |             |                         |        |
| GBW                        | Gain-bandwidth product                     | -   | -                       | 5.5         | -                       | MHz    |
| SR                         | Slew rate                                  | G = 1   | -                       | 2           | -                       | V/µs   |
|                            |  | Settling to 0.1%, 2-V step , G = 1  | -                       | 1.6         | -                       | μs     |
| t <sub>S</sub>             | Settling time                              | Settling to 0.01%, 2-V step , G = 1   | -                       | 2           | -                       | μs     |
| -                          | Overload recovery time                     | $V_{IN} \times gain > V_S$  | -                       | 0.33        | -                       | μs     |
| -                          |  | $V_{\rm IN} \times {\rm gain} > V_{\rm S}$                                  | -                       | 0.33        | -                       | μs     |

Notes: 9. Limits over the full temperature are guaranteed by design, but not tested in production.

10. After mounted to PCB, Vos value will be different to spec, the delta value depend on PCB solder stress, the max value is between +/- 80uV, per our experiment.

11. AS2376Q, the long-term stability is defined as MAX. VOS shift during life HTOL 1000 hours with TA=+125°C. (Tj=150°C) This Vos drift with time is not a linear function of time, and the shift is greater initially and diminishes over time. This parameter is guaranteed by design.

12. After HTSL 2000 hours with TA=+150°C, the Vos drift test condition is TA=+125°C



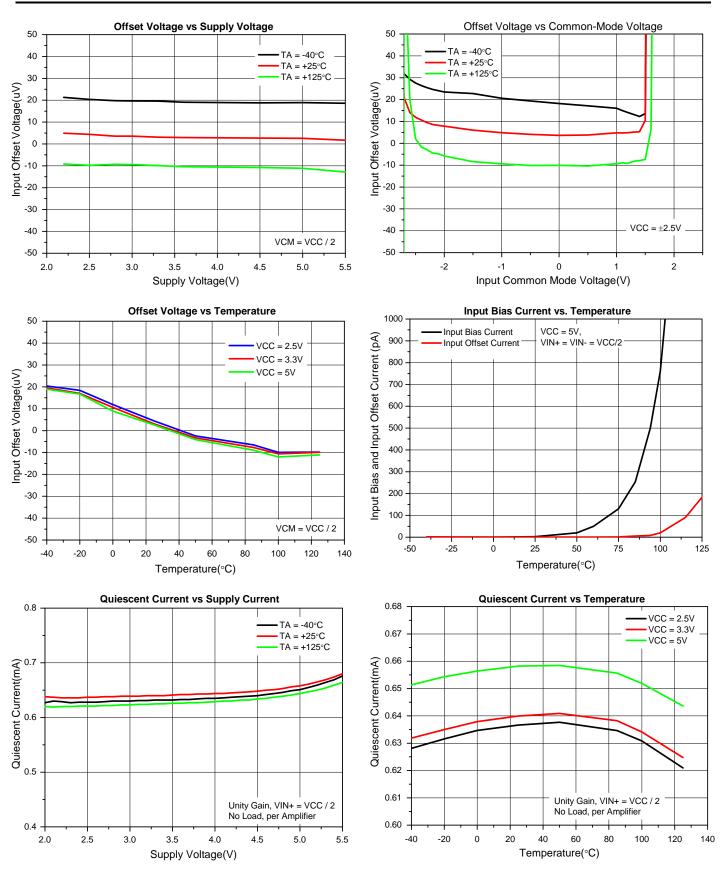
**Electrical Characteristics** (Limits in standard typeface are for  $T_A = +25^{\circ}$ C, **bold** typeface applies over -40°C to +125°C (Note 9), R<sub>L</sub> = 10 k $\Omega$  connected to V<sub>S</sub> / 2, V<sub>CM</sub> = V<sub>S</sub> / 2, and V<sub>OUT</sub> = V<sub>S</sub> / 2, unless otherwise noted.)

|                   | PARAMETER               | TEST CONDITIONS   | MIN    | ТҮР                  | MAX | UNIT |
|-------------------|-------------------------|---|--------|----------------------|-----|------|
| OUTPU             | т                       | -   |        |                      | -   |      |
|                   |                         | $T_{A} = 25^{\circ}C, R_{L} = 10 \text{ k}\Omega$                   | -      | 10                   | 20  | mV   |
| -                 | Voltage output swing    | $T_A = -40^{\circ}$ C to +125°C, R <sub>L</sub> = 10 kΩ             | -      | -                    | 40  | mV   |
|                   | from rail               | $T_A = 25^{\circ}C, R_L = 2 k\Omega$                                | -      | 40                   | 50  | mV   |
|                   |                         | $T_A = -40^{\circ}$ C to +125°C, $R_L = 2 \text{ k}\Omega$          | -      | -                    | 80  | mV   |
| I <sub>SC</sub>   | Short-circuit current   | -   | -      | +30, –50             | -   | mA   |
| $C_{\text{LOAD}}$ | Capacitive load drive   | -   | See Ty | pical Characteristic | s   | -    |
| $R_O$             | Open-loop output        | -   | -      | 150                  | -   | Ω    |
| POWER             | RSUPPLY                 |   |        |                      |     | 1    |
|                   | Specified voltage range | -   | 2.2    |                      | 5.5 | V    |
| Vs                | Operating voltage range | -   | -      | 2 to 5.5             |     | V    |
| la                | Quiescent current per   | $T_A = 25^{\circ}C$ , $I = 0$ , $V = 5.5 V$ , $VCM < (V^+) - 1.3 V$ | -      | 760                  | 950 | μA   |
| IQ                | amplifier               | T <sub>A</sub> = -40°C to +125°C                                    | -      | -                    | 1   | mA   |
| TEMPE             | RATURE                  | -   |        |                      | -   |      |
| -                 | Specified range         | -   | -40    | -                    | 125 | °C   |
| -                 | Operating range         | -   | -40    | -                    | 150 | °C   |

Note: 9. Limits over the full temperature are guaranteed by design, but not tested in production.

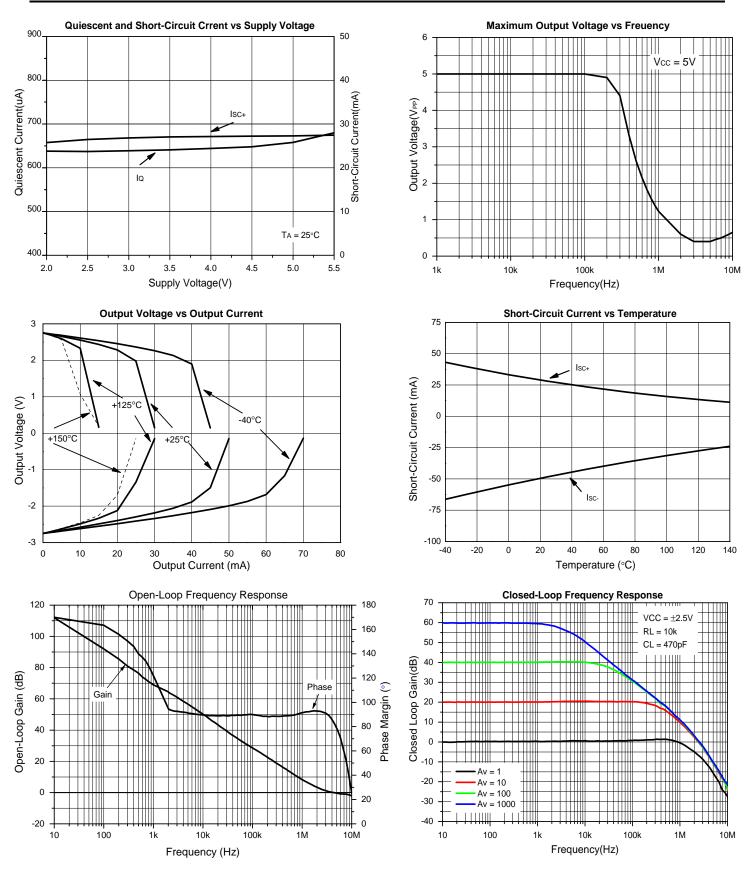


## **Performance Characteristics**





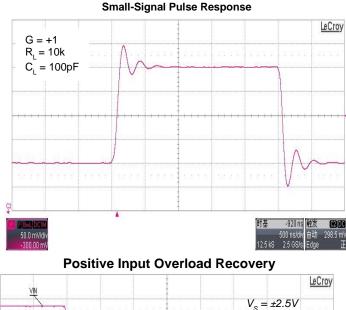
## Performance Characteristics (continued)

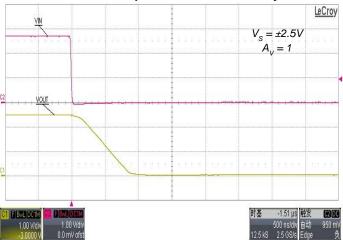


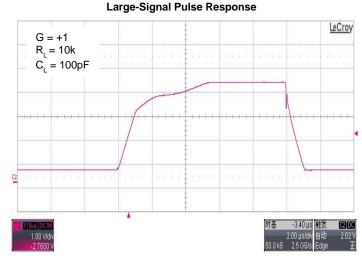
AS2376Q Document number: DS45184 Rev. 2 - 2



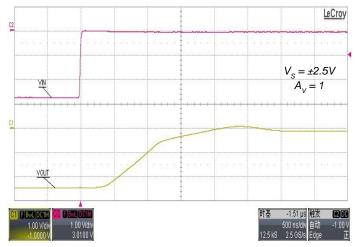
# Performance Characteristics (continued)

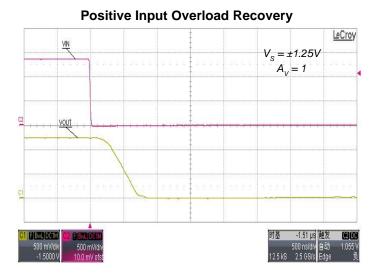




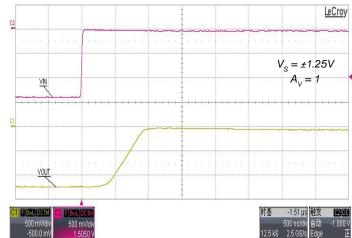


Negative Input Overload Recovery





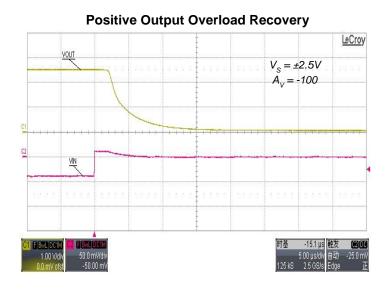
**Negative Input Overload Recovery** 



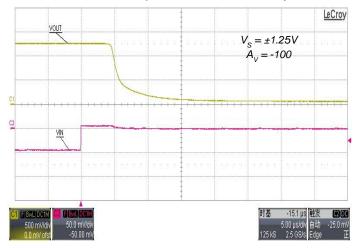
AS2376Q Document number: DS45184 Rev. 2 - 2



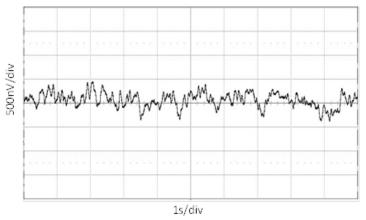
# Performance Characteristics (continued)



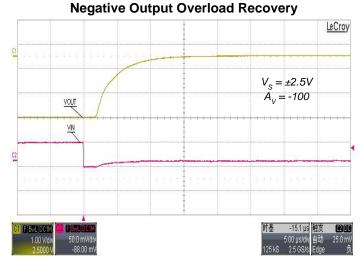
**Positive Output Overload Recovery** 



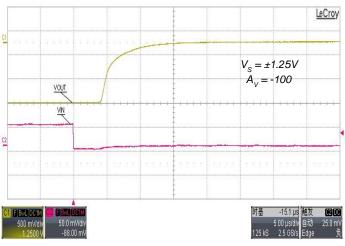
0.1-Hz to 10-Hz Input Voltage Noise



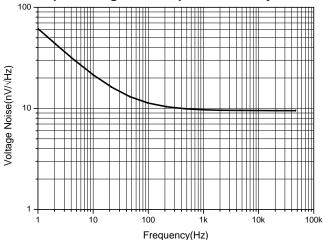
0.1-Hz to 10-Hz Input Voltage Noise



**Negative Output Overload Recovery** 



Input Voltage Noise Spectral Density





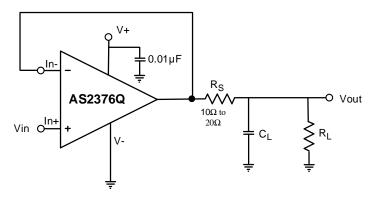
## **Application Information**

#### Overview

The AS2376Q combines low offset (25µV, maximum) and 5.5MHz bandwidth for a wide variety of filtering and control applications. Many op amps use chopper stabilization to achieve low offset voltage but this normally comes with a restriction of bandwidth to less than 500kHz. The offset of the AS2376Q is addressed by using post package trim allowing for the retention of significant bandwidth.

#### Stability Considerations when Driving Capacitive Loads

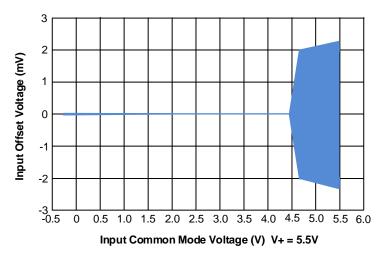
Operational amplifiers are prone to oscillation when required to drive large capacitive loads. The AS2376Q is capable of driving a 250 picofarad load at unity gain. Larger loads will require the insertion of a nulling resistor (denoted as  $R_s$ ) in series with the load capacitor. The suggested nulling resistor value is 10 $\Omega$  to 20 $\Omega$ . This addition will introduce a small error but is negligible in most applications.



**Circuit for Driving Large Capacitive Loads** 

#### Offset Voltage as Input Common Mode Approaches V+

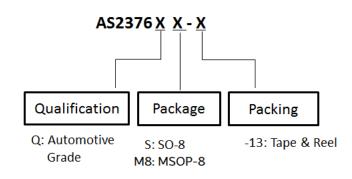
The AS236Q has an input circuitry configuration that is common to most rail to rail input operational amplifiers. At the low end of the common mode input voltage range, the input signals are processed by a differential pair of PMOS transistors. This portion of the circuit has been precision adjusted with post package trim allowing the offset to be in the microvolts range. As the input common mode voltage approaches approximately one volt less than the positive supply, the inputs are transitioned to a second differential pair of NMOS transistors. This portion of the op amp has an offset voltage similar to a conventional op amp. As noted in the heading of the Electrical Characteristics Section, the precision offset voltage is optimized at a common mode of one half of the supply voltage. This conceptual chart depicts the approximate best case of extending the precision common mode area by using the device at 5.5V supply.



## Offset Voltage over Common Mode Voltage Range

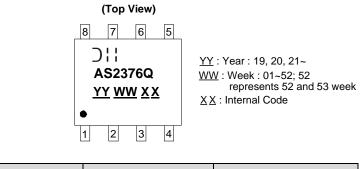


## **Ordering Information**

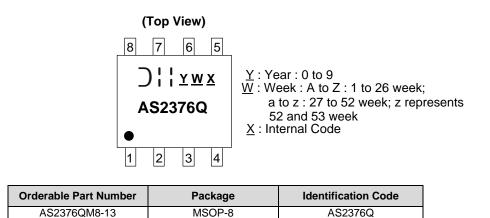


| Orderable    | Paakaga Cada Paakaga |         | Packing  |                    |               |  |
|--------------|----------------------|---------|----------|--------------------|---------------|--|
| Part Number  | Package Code         | Package | Quantity | Part Number Suffix | Carrier       |  |
| AS2376QS-13  | S                    | SO-8    | 2,500    | -13                | Tape and Reel |  |
| AS2376QM8-13 | M8                   | MSOP-8  | 2,500    | -13                | Tape and Reel |  |

## **Marking Information**



| Orderable Part Number | Package | Identification Code |
|-----------------------|---------|---------------------|
| AS2376QS-13           | SO-8    | AS2376Q             |

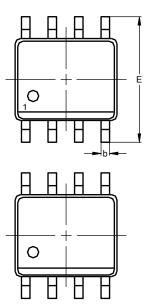




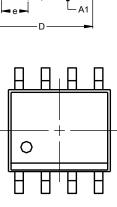
# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



OPTION A (TOP VIEW)



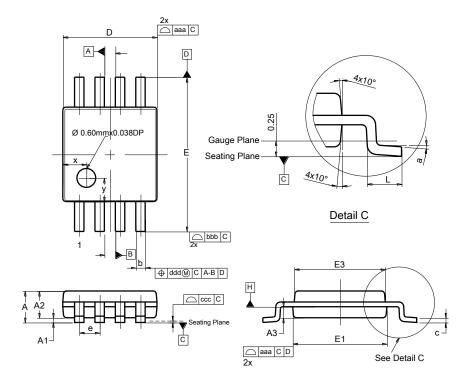
A2

OPTION B (TOP VIEW)

|   | E1                              |
|---|---------------------------------|
|   |                                 |
| Ā |                                 |
| Ă | Ø Gauge Plane<br>Seating Plane  |
|   | `` _ <b>→</b> └└ <del>~</del> ` |

| 5   | SO-8 (Standard) |           |      |  |  |  |  |
|-----|-----------------|-----------|------|--|--|--|--|
| Dim | Min             | Max       | Тур  |  |  |  |  |
| Α   |                 | 1.75      |      |  |  |  |  |
| A1  | 0.10            | 0.25      | -    |  |  |  |  |
| A2  | 1.25            | 1.65      | -    |  |  |  |  |
| A3  | 0.50            | 0.70      |      |  |  |  |  |
| b   | 0.30            | 0.51      |      |  |  |  |  |
| С   | 0.15            | 0.25      | -    |  |  |  |  |
| D   | 4.80            | 5.00      |      |  |  |  |  |
| E   | 5.80            | 6.20      | 6.00 |  |  |  |  |
| E1  | 3.80            | 4.00      |      |  |  |  |  |
| е   | -               |           | 1.27 |  |  |  |  |
| h   | 0.25            | 0.50      |      |  |  |  |  |
| L   | 0.45            | 0.82      |      |  |  |  |  |
| Ø   | 0°              | 8°        |      |  |  |  |  |
| All | Dimensi         | ions in r | nm   |  |  |  |  |

MSOP-8



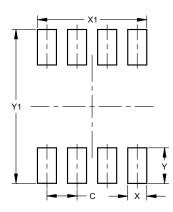
| MSOP-8 |         |          |       |  |  |
|--------|---------|----------|-------|--|--|
| Dim    | Min     | Max      | Тур   |  |  |
| Α      |         | 1.10     |       |  |  |
| A1     | 0.05    | 0.15     | 0.10  |  |  |
| A2     | 0.75    | 0.95     | 0.86  |  |  |
| A3     | 0.29    | 0.49     | 0.39  |  |  |
| b      | 0.22    | 0.38     | 0.30  |  |  |
| С      | 0.08    | 0.23     | 0.15  |  |  |
| D      | 2.90    | 3.10     | 3.00  |  |  |
| Е      | 4.70    | 5.10     | 4.90  |  |  |
| E1     | 2.90    | 3.10     | 3.00  |  |  |
| E3     | 2.85    | 3.05     | 2.95  |  |  |
| е      |         |          | 0.65  |  |  |
| L      | 0.40    | 0.80     | 0.60  |  |  |
| а      | 0°      | 8°       | 4°    |  |  |
| x      |         |          | 0.750 |  |  |
| У      |         |          | 0.750 |  |  |
| aaa    | 0.20    |          |       |  |  |
| bbb    | 0.25    |          |       |  |  |
| CCC    | 0.10    |          |       |  |  |
| ddd    | 0.13    |          |       |  |  |
| All    | Dimensi | ons in r | nm    |  |  |
|        |         |          |       |  |  |



# **Suggested Pad Layout**

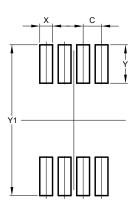
Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SO-8



| <u>.</u>   |               |
|------------|---------------|
| Dimensions | Value (in mm) |
| С          | 1.27          |
| Х          | 0.802         |
| X1         | 4.612         |
| Y          | 1.505         |
| Y1         | 6.50          |

MSOP-8



| Dimensions | Value<br>(in mm) |
|------------|------------------|
| C          | 0.650            |
| Х          | 0.450            |
| Ý          | 1.350            |
| Y1         | 5.300            |

## **Mechanical Data**

#### SO-8

- Package Material: Molded Plastic, UL Flammability Rating 94V-0
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)
- Max Soldering Temperature +260°C for 30 secs as per JEDEC J-STD-020

#### MSOP-8

- Package Material: Molded Plastic, UL Flammability Rating 94V-0
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 3
- Weight: 0.035 grams (Approximate)
- Max Soldering Temperature +260°C for 30 secs as per JEDEC J-STD-020



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